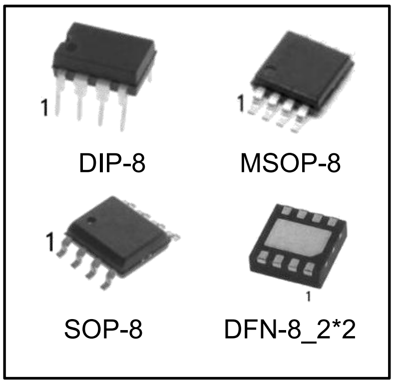
1MHZ CMOS Rail-to-Rail IO Opamp with RF Filter

Features

- Single-Supply Operation from +2.1V ~ +5.5V
- Rail-to-Rail Input / Output
- Gain-Bandwidth Product: 1MHz (Typ.)
- Low Input Bias Current: 1pA (Typ.)
- Low Offset Voltage: 3.5mV (Max.)
- Quiescent Current: 40μA per Amplifier (Typ.)
- Operating Temperature: -40°C ~ +125°C
- Embedded RF Anti-EMI Filter



Ordering Information

DEVICE	Package Type	MARKING	Packing	Packing Qty
LMV602PG	DIP-8	LMV602	TUBE	2000pcs/Box
LMV602DRG	SOP-8	LMV602	REEL	2500pcs/Reel
LMV602DGKRG	MSOP-8	LMV602,V602	REEL	3000pcs/Reel
LMV602DQRG	DFN-8 _2*2	LMV602	REEL	2500pcs/Reel

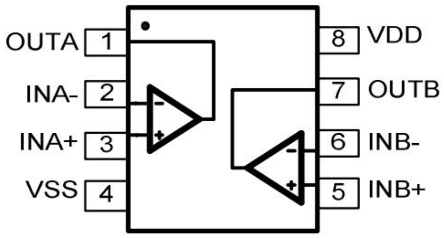
General Description

The LMV602 have a high gain-bandwidth product of 1MHz, a slew rate of 0.6V/μs, and a quiescent current of 40μA/amplifier at 5V. The LMV602 is designed to provide optimal performance in low voltage and low noise systems. They provide rail-to-rail output swing into heavy loads. The input common mode voltage range includes ground, and the maximum input offset voltage is 3.5mV for LMV602. They are specified over the extended industrial temperature range (-40℃ to+125℃). The operating range is from 2.1V to 5.5V. The LMV602 Dual is available in Green SOP-8, MSOP8,DIP-8 and DFN-8 packages.

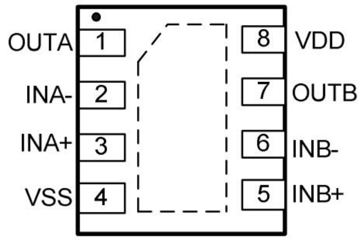
Applications

- ASIC Input or Output Amplifier
- Sensor Interface
- Medical Communication
- Smoke Detectors
- Audio Output
- Piezoelectric Transducer Amplifier
- Medical Instrumentation
- Portable Systems

Pin Configuration



SOP-8/DIP-8/MSOP-8



DFN-8 2*2

Figure 1. LMV602 Pin Assignment Diagram

Absolute Maximum Ratings

Condition	Min	Max
Power Supply Voltage (V_{DD} to Vss)	-0.5V	+7.5V
Analog Input Voltage (IN+ or IN-)	Vss-0.5V	V_{DD}+0.5V
PDB Input Voltage	Vss-0.5V	+7V
Operating Temperature Range	-40°C	+125°C
Junction Temperature	+160°C	
Storage Temperature Range	-55°C	+150°C
Lead Temperature (soldering, 10sec)	+245°C	
Package Thermal Resistance (TA=+25℃)		
SOP-8, θJA	125°C/W	
MSOP-8, θJA	216°C/W	
ESD Susceptibility		
HBM	6KV	
MM	300V	

Note: Stress greater than those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions outside those indicated in the operational sections of this specification are not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

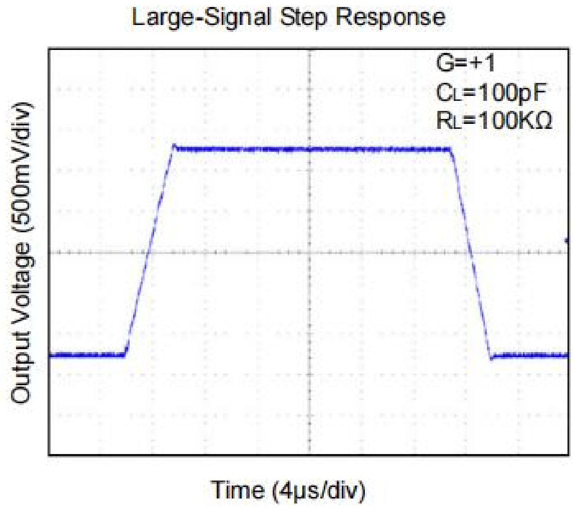
Electrical Characteristics

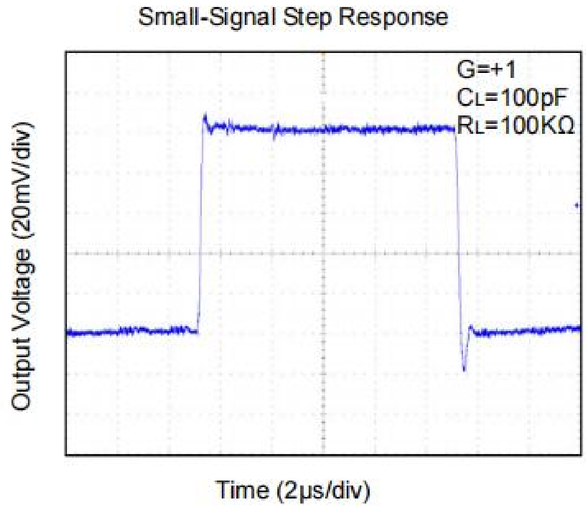
(At V_S = +5V, R_L = 100kΩ connected to V_S/2, and V_{OUT} = V_S/2, unless otherwise noted.)

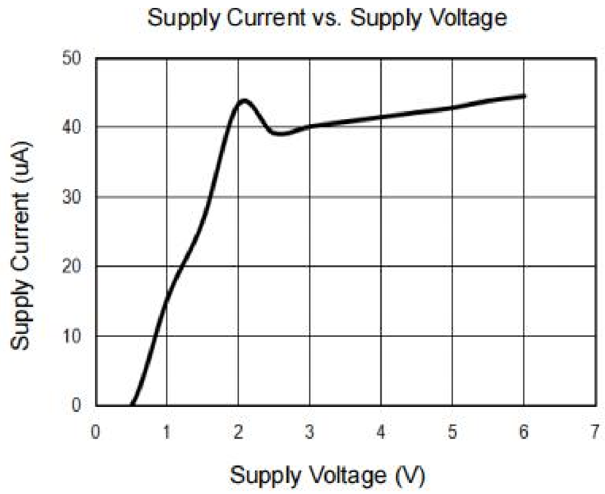
PARAMETER	SYMBOL	CONDITIONS	TYP	MIN/MAX OVER TEMPERATURE			
			+25℃	+25℃	-40℃to+85℃	UNITS	MIN/MAX
INPUT CHARACTERISTICS							
Input Offset Voltage	V_{OS}	V_{CM} = VS/2	0.4	3.5	5.6	mV	MAX
Input Bias Current	I_B		1			pA	TYP
Input Offset Current	I_{OS}		1			pA	TYP
Common-Mode Voltage Range	V_{CM}	V_S = 5.5V	-0.1 to +5.6			V	TYP
Common-Mode Rejection Ratio	CMRR	V_S=5.5V, V_{CM} = -0.1V to 4V	70	62	62	dB	MIN
		V_S=5.5V, V_{CM}= -0.1V to 5.6V	68	56	55		
Open-Loop Voltage Gain	A_{OL}	R_L=5kΩ, V_O= +0.1V to +4.9V	80	70	70	dB	MIN
		R_L=10kΩ, V_O=+0.1V to +4.9V	100	90	85		
Input Offset Voltage Drift	$\Delta V_{OS}/\Delta_T$		2.7			μV/℃	TYP
OUTPUT CHARACTERISTICS							
Output Voltage Swing from Rail	V_{OH}	R_L = 100kΩ	4.997	4.990	4.980	V	MIN
	V_{OL}	R_L = 100kΩ	3	10	20	mV	MAX
	V_{OH}	R_L = 10kΩ	4.992	4.970	4.960	V	MIN
	V_{OL}	R_L = 10kΩ	8	30	40	mV	MAX
Output Current	I_{SOURCE}	R_L = 10Ω to VS/2	84	60	45	mA	MIN
	I_{SINK}		75	60	45		
POWER SUPPLY							
Operating Voltage Range				2.1	2.5	V	MIN
				5.5	5.5	V	MAX
Power Supply Rejection Ratio	PSRR	V_S = +2.5V to +5.5V, V_{CM} = +0.5V	82	60	58	dB	MIN
Quiescent Current / Amplifier	I_Q		40	60	80	μA	MAX
DYNAMIC PERFORMANCE (CL = 100pF)							
Gain-Bandwidth Product	GBP		1			MHz	TYP
Slew Rate	SR	G = +1, 2V Output Step	0.6			V/μs	TYP
Settling Time to 0.1%	t_S	G = +1, 2V Output Step	5			μs	TYP
Overload Recovery Time		V_{IN} ·Gain = VS	2.6			μs	TYP
NOISE PERFORMANCE							
Voltage Noise Density	e_n	f = 1kHz	27			nV /√Hz	TYP
		f = 10kHz	20			nV/√Hz	TYP

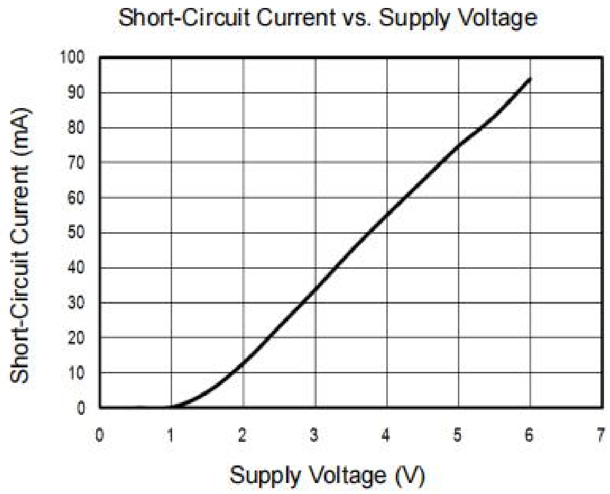
Typical Performance characteristics

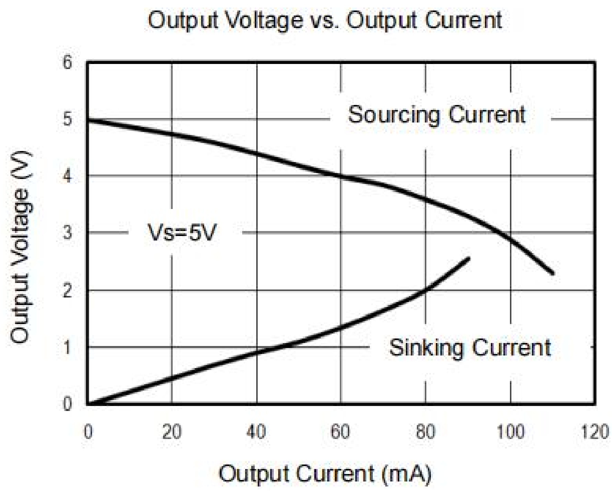
At T_A=+25°C, V_S=+5V, and R_L=100KΩ connected to V_S/2, unless otherwise noted.

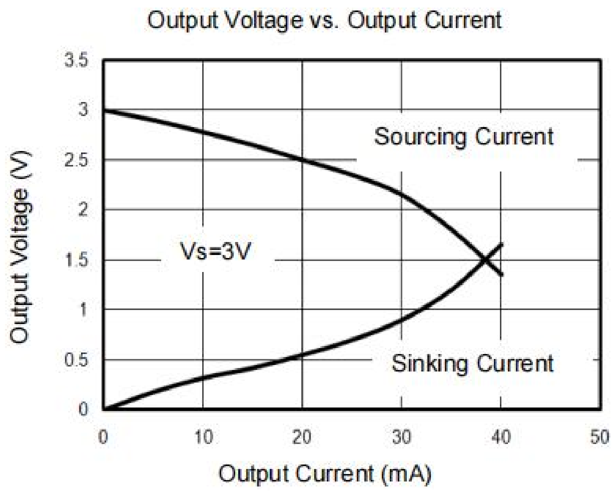












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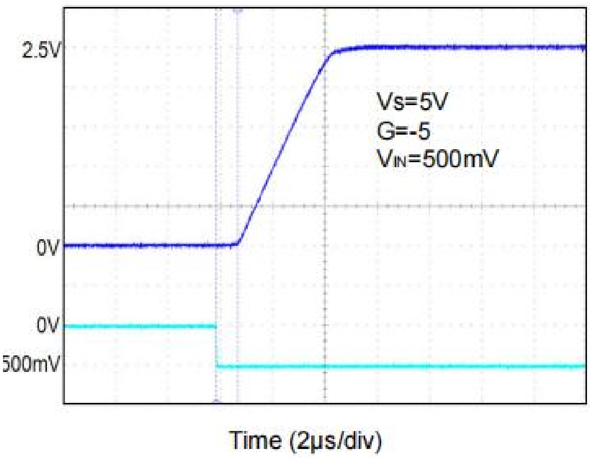
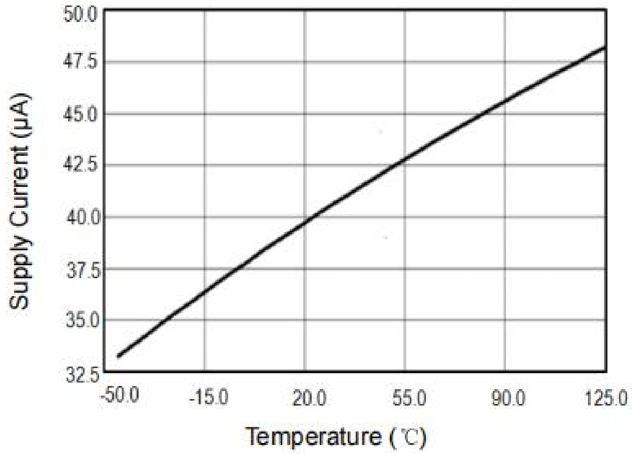
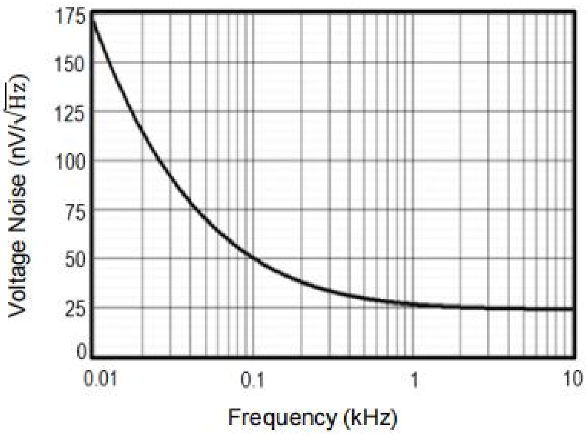
Overload Recovery Time



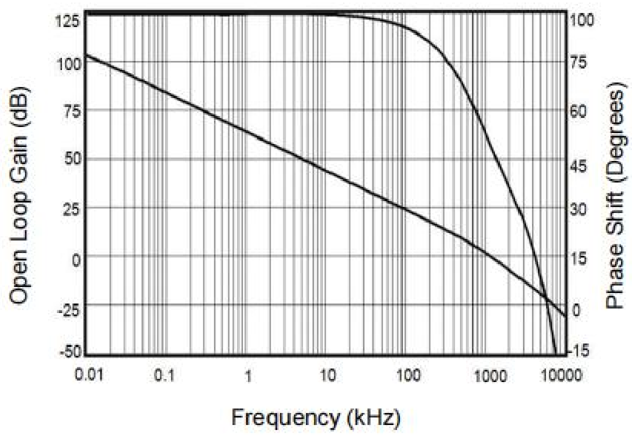
Supply Current vs. Temperature



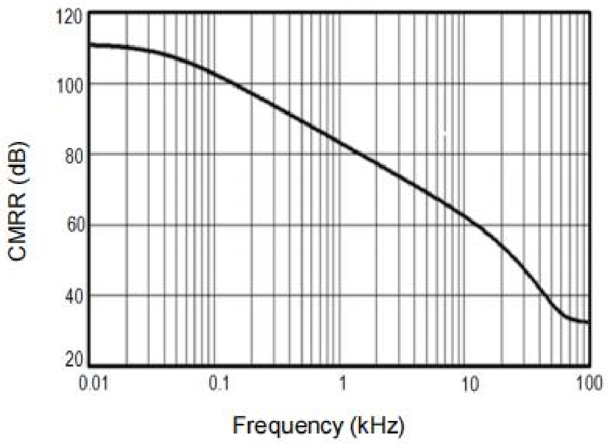
Input Voltage Noise Spectral Density vs. Frequency



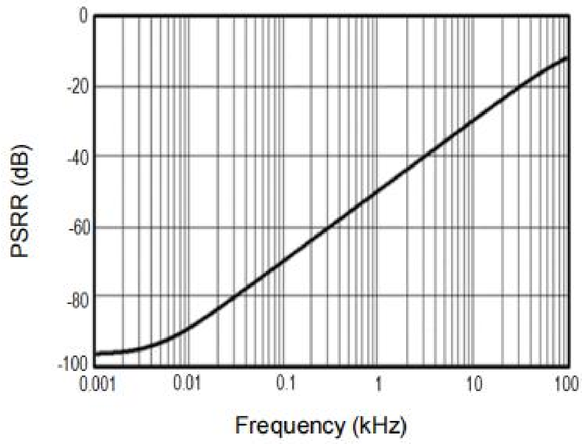
Open Loop Gain, Phase Shift vs. Frequency at +5V



CMRR vs. Frequency



PSRR vs. Frequency



Application Note

Power Supply Bypassing and Board Layout

LMV602 series operates from a single 2.1V to 5. 5V supply or dual ±1.05V to ±2.75V supplies. For best performance, a 0.1μF ceramic capacitor should be placed close to the VDD pin in single supply operation. For dual supply operation, both V_{DD} and VSS supplies should be bypassed to ground with separate 0.1μF ceramic capacitors.

Low Supply Current

The low supply current (typical 40uA per channel) of LMV602 will help to maximize battery life. They are ideal for battery powered systems

Operating Voltage

LMV602 operates under wide input supply voltage (2.1V to 5.5V). In addition, all temperature specifications apply from -40°C to +125°C. Most behavior remains unchanged throughout the full operating voltage range. These guarantees ensure operation throughout the single Li-Ion battery lifetime

Rail-to-Rail Input

The input common-mode range of LMV602 extends 100mV beyond the supply rails (VSS-0.1V to VDD+0.1V). This is achieved by using complementary input stage. For normal operation, inputs should be limited to this range.

Rail-to-Rail Output

Rail-to-Rail output swing provides maximum possible dynamic range at the output. This is particularly important when operating in low supply voltages. The output voltage of LMV602 can typically swing to less than 5 mV from supply rail in light resistive loads (>100kΩ), and 30mV of supply rail in moderate resistive loads (10kΩ).

Capacitive Load Tolerance

The LMV602 is optimized for bandwidth and speed, not for driving capacitive loads. Output capacitance will create a pole in the amplifier's feedback path, leading to excessive peaking and potential oscillation. If dealing with load capacitance is a requirement of the application, the two strategies to consider are (1) using a small resistor in series with the amplifier's output and the load capacitance and (2) reducing the bandwidth of the amplifier's feedback loop by increasing the overall noise gain. Figure 2. shows a unity gain follower using the series resistor strategy. The resistor isolates the output from the capacitance and, more importantly, creates a zero in the feedback path that compensates for the pole created by the output capacitance.

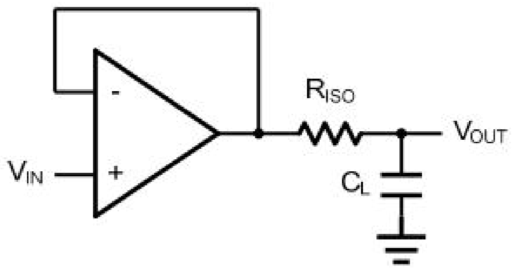


Figure 2. Indirectly Driving a Capacitive Load Using Isolation Resistor

The bigger the RISO resistor value, the more stable VOUT will be. However, if there is a resistive load RL in parallel with the capacitive load, a voltage divider (proportional to RISO/RL) is formed, this will result in a gain error.

The circuit in Figure 3 is an improvement to the one in Figure 2. RF provides the DC accuracy by feed-forward the VIN to RL. CF and RISO serve to counteract the loss of phase margin by feeding the high frequency component of the output signal back to the amplifier’s inverting input, thereby preserving the phase margin in the overall feedback loop. Capacitive drive can be increased by increasing the value of CF. This in turn will slow down the pulse response.

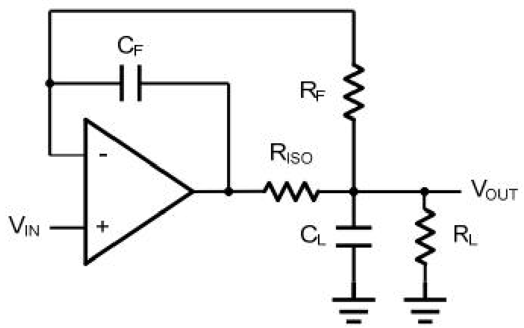
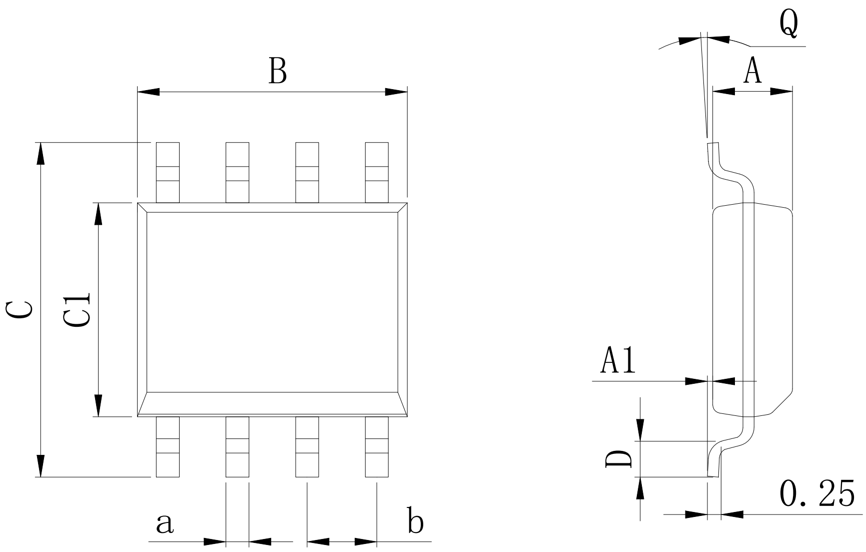


Figure 3. Indirectly Driving a Capacitive Load with DC Accuracy

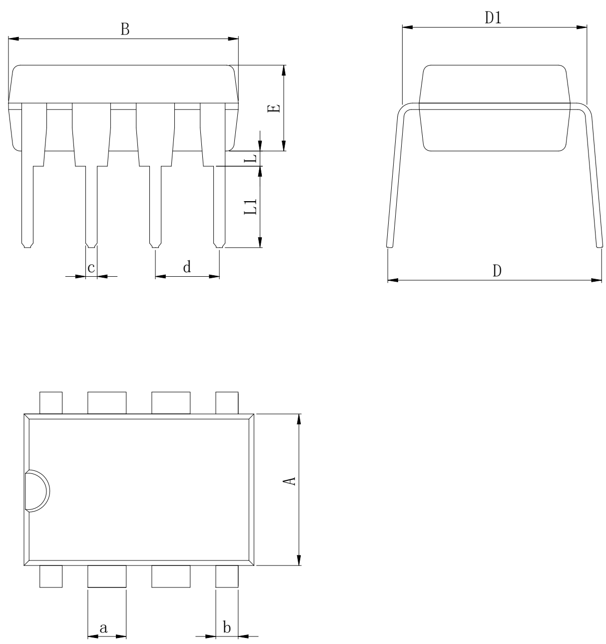
Physical Dimensions

SOP-8



Dimensions In Millimeters(SOP-8)									
Symbol:	A	A1	B	C	C1	D	Q	a	b
Min:	1.35	0.05	4.90	5.80	3.80	0.40	0°	0.35	1.27 BSC
Max:	1.55	0.20	5.10	6.20	4.00	0.80	8°	0.45	

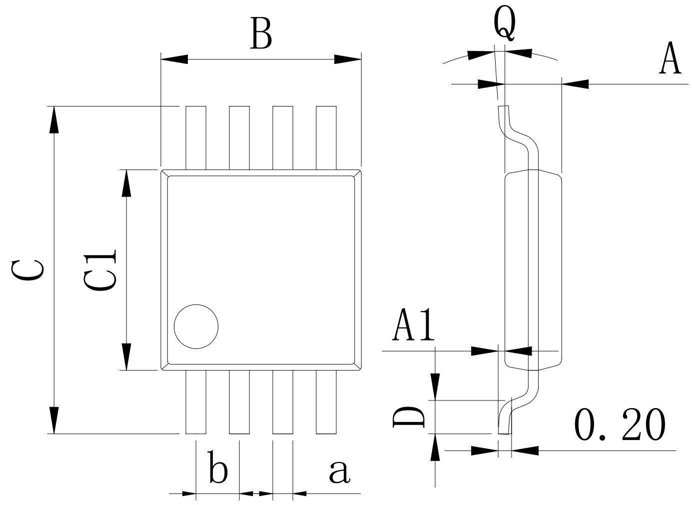
DIP-8



Dimensions In Millimeters(DIP-8)											
Symbol:	A	B	D	D1	E	L	L1	a	b	c	d
Min:	6.10	9.00	8.10	7.42	3.10	0.50	3.00	1.50	0.85	0.40	2.54 BSC
Max:	6.68	9.50	10.9	7.82	3.55	0.70	3.60	1.55	0.90	0.50	

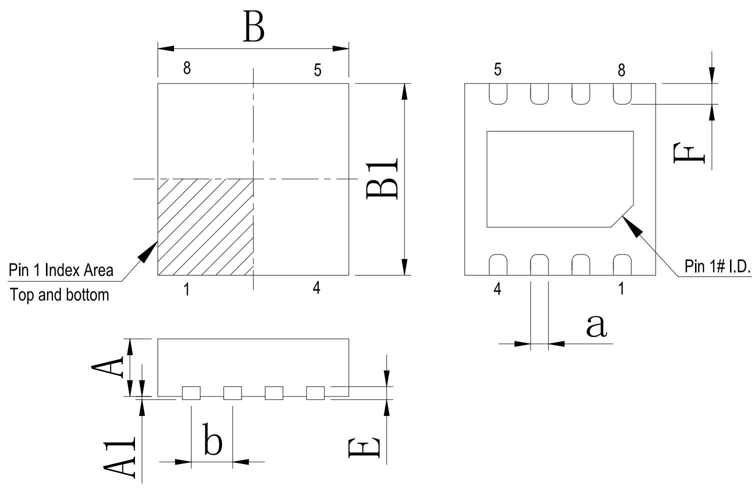
Physical Dimensions

MSOP-8



Dimensions In Millimeters(MSOP-8)									
Symbol:	A	A1	B	C	C1	D	Q	a	b
Min:	0.80	0.05	2.90	4.75	2.90	0.35	0°	0.25	0.65 BSC
Max:	0.90	0.20	3.10	5.05	3.10	0.75	8°	0.35	

DFN-8 2*2



Dimensions In Millimeters(DFN-8 2*2)								
Symbol:	A	A1	B	B1	E	F	a	b
Min:	0.85	0	1.90	1.90	0.15	0.25	0.18	0.50TYP
Max:	0.95	0.05	2.10	2.10	0.25	0.45	0.30	

Revision History

DATE	REVISION	PAGE
2014-6-4	New	1-11
2023-8-28	Update encapsulation type、Update Lead Temperature、Updated DIP-8 dimension	1、2、8

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